506703181 06/08/2021

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
FAN DONG MENG	05/27/2021
YUN LONG LIANG	05/27/2021
JIN CHAO ZHANG	05/27/2021
JIE ZHOU	05/28/2021
JIN AN XU	05/28/2021

RECEIVING PARTY DATA

Name:	TENCENT TECHNOLOGY (SHENZHEN) COMPANY LTD	
Street Address:	35/F, TENCENT BUILDING, KEJIZHONGYI ROAD	
Internal Address:	MIDWEST, DISTRICT OF HI-TECH PARK, NANSHAN DISTRICT	
City:	SHENZHEN	
State/Country:	CHINA	
Postal Code:	518057	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17341614

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	Q263682	
NAME OF SUBMITTER:	RENEE P. ADAMS	
SIGNATURE:	/Renee P. Adams/	
DATE SIGNED:	06/08/2021	

PATENT REEL: 056466 FRAME: 0530 506703181

Total Attachments: 3

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PATENT REEL: 056466 FRAME: 0531

Docket No.: <u>Q263682</u> **Only After Sept 16, 2012**

ASSIGNMENT WITH DECLARATION FOR PATENT APPLICATION (37 CFR 1.63)

專利申請轉讓聲明書(37 CFR 1.63)

Chinese Language Assignment with Declaration

鑒於,我/我們,即下面簽名之發明人(以下簡稱「轉讓人」),已發明下文確認之申請中所述的若干改善之處;和	Whereas, I/We, the undersigned inventor(s) hereinafter called assignor(s), have invented certain improvements described in the application identified below; and
鑒於,(地址位於)(「承讓人」)意欲購買申請和發明以及就此隨後獲取的任何美國專利中的全部權利、所有權和權益;	Whereas, TENCENT TECHNOLOGY (SHENZHEN) COMPANY LTD of 35/F, Tencent Building, Kejizhongyi Road, Midwest, District of Hi-tech Park, Nanshan District, Shenzhen, 518057, China, (assignee), desires to acquire the entire right, title, and interest in the application and invention, and to any United States patents to be obtained therefor;
因此,就有值代價而言,相關收據特此確認:	Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,
我/我們,上文指名轉讓人,特此向上文指名承讓人及其繼承人和受讓人出售、轉讓及出讓該申請中適用於美利堅合眾國的全部權利、所有權和權益,及該申請中披露的適用於美利堅合眾國的發明(包括該申請的所有分案和延續申請),及可能據此頒發的所有美國專利證書及所有再頒發之專利證書(包括35 USC 119項下的要求優先權的權利及就過往損害賠償提起訴訟的權利),及適用於所有其他國家的發明(包括經修訂1883年巴黎國際公約項下的優先權);我/我們請求美國專利及商標局局長向承讓人及其繼承人和受讓人簽發該申請中所載列之發明的任何專利證書;及我/我們特此同意承讓人可申請外國發明之專利證書,且我/我們將會應承讓人的要求,無償簽立承讓人申請美國和外國專利所必需的所有文件。	I/We, the above named assignor(s), hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including all divisions, and continuations thereof, and all Letters Patent of the United States that may be granted thereon, and all reissues thereof, and all countries foreign thereto, including rights of priority under the International Convention of Paris (1883) as amended, including the right to claim priority under 35 USC 119 and the right to sue for past damages, and I/we request the Director of the U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns; and I/we hereby agree that the assignee may apply for foreign Letters Patent on the invention and I/we will execute without further consideration all papers deemed necessary by the assignee in connection with the United States and foreign applications when called upon to do so by the assignee.
(合法化審批無需記錄,但須作為35 USC 261項下執行的表面 證據)	(Legalization not required for recording but is prima facie evidence of execution under 35 USC 261)
作為下述發明人,我特此聲明:	As the below named inventor, I hereby declare that:
該轉讓聲明書乃有關:	This assignment with declaration is directed to:
□ 隨附的申請或	☐ The attached application, or
□ 於日提交的 美國專利申請或PCT國際申請號碼 。	United States Application or PCT International Application Number filed on
該申請有權:	The application is entitled:
	INFORMATION PROCESSING METHOD AND APPARATUS, AND STORAGE MEDIUM

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Chinese Assignment with Declaration

我已做出或授權他人做出上述確認的申請。

我相信我是申請中要求保護的發明的原始發明人或原始聯合 發明人之一。

我已讀閱並了解提出該轉讓聲明的申請內容。

根據37 CFR 1.56之規定, 我知悉我有義務向專利局透露據我 所知的有關專利性的所有實質性資訊。

特此確認,根據18 USC 1001之規定,於本轉讓聲明書中蓄意 做出任何虛假聲明會被處以罰款或五 (5) 年以下監禁或兩者 **並**罰。

The above identified application was made or was authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I have reviewed and understand the contents of the application for which this assignment with declaration is being submitted.

I am aware of the duty to disclose to the Office all information known to me to be material to patentability as defined in 37 CFR 1.56.

I hereby acknowledge that any willful false statement made in this assignment with declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both.

STATEMENT OF ACCURATE TRANSLATION IN ACCORDANCE WITH 37 CFR 1.69(b):

The assignment with declaration is an accurate translation of the corresponding English language assignment with declaration.

Signature

Date

March 17, 2014

AME OF SOLE OR FIRST INVENTOR: 注一發明人或第一發明人姓名:	*****
siven Name (first and middle [if any]) 6字(名和中名[若有]) Fan Dong	Family Name or Surname 姓氏 MENG
rventor's signature 专明人簽名 Fan Dong Mang	Date 日期 2021、5、2.7
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AME OF SECOND INVENTOR: 二發明人姓名:	
iven Name (first and middle [if any]) ;字(名和中名[若有]) Yun Long	Family Name or Surname 姓氏 LIANG
nventor's signature 資明人簽名 Yun Long Jang	Date 日期 >02 /
esidence: E所: Shenzhen, China	
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IAME OF THIRD INVENTOR: 第三發明人姓名:	
Siven Name (first and middle [if any]) A字(名和中名[若有])	Family Name or Surname 姓氏 ZHANG
nventor's signature 奏明人簽名	Date 日期 ルンノ・よ・2 7
tesidence: i:/fi: Shenzhen, China	
	Midwest District of Hi-tech Park, Nanshan District, Shenzhen,
NAME OF FOURTH INVENTOR: 第四發明人姓名:	
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nventor's signature 發明人簽名	Date 日場 フッソ. じ. 比
Residence: 注析: Shenzhen, China	•
	Midwest District of Hi-tech Park, Nanshan District, Shenzhen,
NAME OF FIFTH INVENTOR: 第五發明人姓名:	
Given Name (first and middle [if any]) 名字(名和中名[若有]) Jin An	Family Name or Surname 姓氏
inventor's signature 發明人簽名 Jin An Xu	Date 日明 7071. ち. 28
Residence: 住所: Shenzhen, China	
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RECORDED: 06/08/2021

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